

March 2013

FGA15N120FTD 1200 V, 15 A Field Stop Trench IGBT

Features

- Field Stop Trench Technology
- · High Speed Switching
- Low Saturation Voltage: V_{CE(sat)} = 1.58 V @ I_C = 15 A
- High Input Impedance
- RoHS Complaint

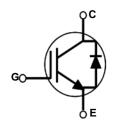
Applications

• Induction Heating, Microwave Oven

General Description

Using advanced field stop trench technology, Fairchild[®] s 1200V trench IGBTs offer superior conduction and switching performances for soft switching applications. The device can operate in parallel configuration with exceptional avalanche ruggedness. This device is designed for induction heating and microwave oven.





Absolute Maximum Ratings

Symbol	Description		Ratings	Unit
V _{CES}	Collector to Emitter Voltage		1200	V
V_{GES}	Gate to Emitter Voltage		± 25	V
I _C	Collector Current	@ T _C = 25°C	30	A
	Collector Current	@ T _C = 100°C	15	A
I _{CM (1)}	Pulsed Collector Current		45	A
I _F	Diode Continuous Forward Current	@ T _C = 100°C	15	A
I _{FM}	Diode Maximum Forward Current		90	A
P _D	Maximum Power Dissipation	$@ T_C = 25^{\circ}C$	220	W
ן י ט	Maximum Power Dissipation	$@ T_C = 100^{\circ}C$	88	W
T _J	Operating Junction Temperature		-55 to +150	°C
T _{stg}	Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

Notes:

1: Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}(IGBT)$	Thermal Resistance, Junction to Case	-	0.57	°C/W
$R_{\theta JC}(Diode)$	Thermal Resistance, Junction to Case	-	2.1	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	-	62.5	°C/W

Package Marking and Ordering Information

Device Marking Device		Package	Reel Size	Tape Width	Quantity
FGA15N120FTD FGA15N120FTDTU		TO-3PN	=	=	30

Electrical Characteristics of the IGBT $T_C = 25$ °C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	eteristics					
BV _{CES}	Collector to Emitter Breakdown Voltage	$V_{GE} = 0V$, $I_C = 1mA$	1200	-	-	V
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$	-	-	1	mA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$	-	-	±250	nA
On Charac	teristics					
V _{GE(th)}	G-E Threshold Voltage	$I_C = 15$ mA, $V_{CE} = V_{GE}$	3.5	6	7.5	V
	I _C = 15A, V _{GE} = 15V	-	1.58	2	V	
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C = 15A, V _{GE} = 15V, T _C = 125°C	-	1.83	-	V
Dynamic C	Characteristics		•	•		
C _{ies}	Input Capacitance		-	2350	-	pF
C _{oes}	Output Capacitance	$V_{CE} = 30V_{,} V_{GE} = 0V_{,}$ f = 1MHz	-	70	-	pF
C _{res}	Reverse Transfer Capacitance	1 = 11VIDZ	-	45	-	pF
<u> </u>	Characteristics		_	33	_	
t _{d(on)}	Turn-On Delay Time		-		-	ns
t _r	Rise Time	$V_{CC} = 600V, I_{C} = 15A,$ $R_{G} = 15\Omega, V_{GE} = 15V,$ Resistive Load, $T_{C} = 25^{\circ}C$	-	80	-	ns
t _{d(off)}	Turn-Off Delay Time Fall Time		-	160	-	
t _f				255	220	ns
E _{on}		Resistive Load, T _C = 25°C	-	255	330	ns
_	Turn-On Switching Loss	Resistive Load, T _C = 25°C	-	0.3	-	ns mJ
E _{off}	Turn-Off Switching Loss	Resistive Load, T _C = 25°C	-	0.3 0.58	0.74	ns mJ mJ
E _{ts}	Turn-Off Switching Loss Total Switching Loss	Resistive Load, T _C = 25°C	-	0.3 0.58 0.88	0.74	ns mJ mJ
E _{ts}	Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time	Resistive Load, T _C = 25°C	-	0.3 0.58 0.88 30	0.74	ns mJ mJ mJ
E _{ts} t _{d(on)} t _r	Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time Rise Time		-	0.3 0.58 0.88 30 115	0.74	ns mJ mJ mJ ns
$\begin{array}{c} E_{ts} \\ \\ t_{d(on)} \\ \\ t_{r} \\ \\ \\ t_{d(off)} \end{array}$	Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time	V _{CC} = 600V, I _C = 15A,		0.3 0.58 0.88 30	0.74	ns mJ mJ mJ
$\begin{aligned} & E_{tS} \\ & t_{d(on)} \\ & t_{r} \\ & t_{d(off)} \\ & t_{f} \end{aligned}$	Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time			0.3 0.58 0.88 30 115 170 390	- 0.74	ns mJ mJ ns ns
$\begin{array}{c} E_{ts} \\ t_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ E_{on} \end{array}$	Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss	$V_{CC} = 600V, I_{C} = 15A,$ $R_{G} = 15\Omega, V_{GE} = 15V,$	- - - - -	0.3 0.58 0.88 30 115 170	- 0.74	ns mJ mJ ns ns ns ns ns
$\begin{aligned} &E_{ts} \\ &t_{d(on)} \\ &t_r \\ &t_{d(off)} \\ &t_f \\ &E_{on} \\ &E_{off} \end{aligned}$	Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss	$V_{CC} = 600V, I_{C} = 15A,$ $R_{G} = 15\Omega, V_{GE} = 15V,$	- - - - -	0.3 0.58 0.88 30 115 170 390 0.38	- 0.74	ns mJ mJ ns ns ns ns mJ mJ
$\begin{aligned} & E_{ts} \\ & t_{d(on)} \\ & t_r \\ & t_{d(off)} \\ & t_f \\ & E_{on} \\ & E_{off} \\ & E_{ts} \end{aligned}$	Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Total Switching Loss	$V_{CC} = 600V, I_{C} = 15A,$ $R_{G} = 15\Omega, V_{GE} = 15V,$	- - - - - -	0.3 0.58 0.88 30 115 170 390 0.38 0.89	- 0.74	ns mJ mJ ns ns ns ns ns ms ms ms ms ms ms ms
$\begin{aligned} &E_{ts} \\ &t_{d(on)} \\ &t_r \\ &t_{d(off)} \\ &t_f \\ &E_{on} \\ &E_{off} \end{aligned}$	Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss	$V_{CC} = 600V, I_{C} = 15A,$ $R_{G} = 15\Omega, V_{GE} = 15V,$	- - - - - - -	0.3 0.58 0.88 30 115 170 390 0.38 0.89 1.27	- 0.74	ns mJ mJ ns ns ns ns ms

Electrical Characteristics of the Diode $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Unit
V _{FM}	Diode Forward Voltage	I _F = 15A	$T_{\rm C} = 25^{\rm o}{\rm C}$	=	1.4	1.8	V
VFM Diode i si ward Voltage	Diode Forward Voltage	1F = 10/A	$T_{\rm C} = 125^{\rm o}{\rm C}$	-	1.42	-	1
t _{rr}	Diode Reverse Recovery Time		$T_C = 25^{\circ}C$	-	575	-	ns
ना	,	I _{ES} =15A,	$T_{\rm C} = 125^{\rm o}{\rm C}$	-	577	-	
I	Diode Peak Reverse Recovery Cyrrent	dl/dt = 200A/μs	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	30	-	Α
1 _{rr}	Blode Fedic Neverse Nesevery Cyrient		$T_{\rm C} = 125^{\rm o}{\rm C}$	-	37	-	, ,
Q _{rr}	Diode Reverse Recovery Charge		$T_{\rm C} = 25^{\rm o}{\rm C}$	-	8.7	-	иC
≪II			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	10.7	-	μΟ

Figure 1. Typical Output Characteristics

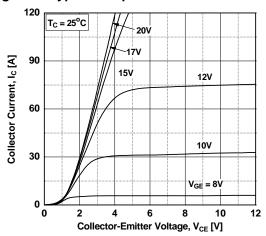


Figure 3. Typical Saturation Voltage Characteristics

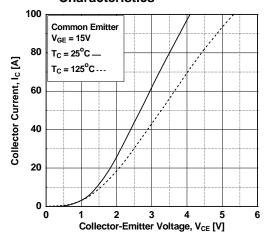


Figure 5. Saturation Voltage vs. Case
Temperature at Variant Current Level

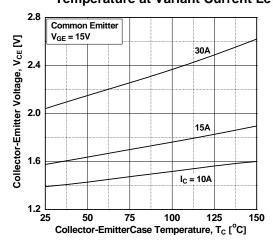


Figure 2. Typical Output Characteristics

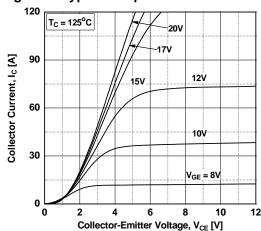


Figure 4. Transfer Characteristics

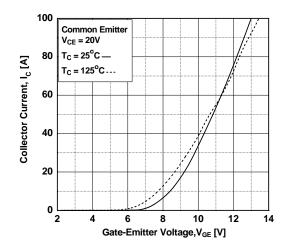


Figure 6. Saturation Voltage vs. V_{GE}

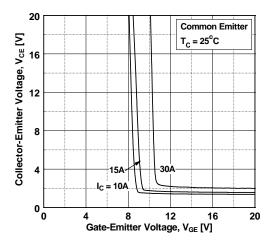


Figure 7. Saturation Voltage vs. V_{GE}

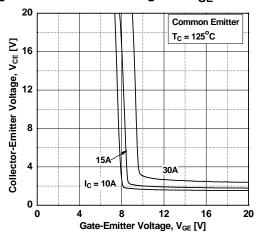


Figure 9. Gate charge Characteristics

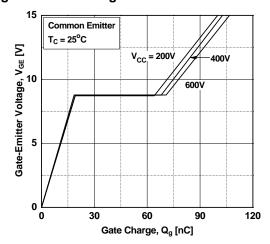


Figure 11. Turn-on Characteristics vs.
Gate Resistance

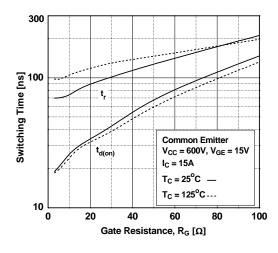


Figure 8. Capacitance Characteristics

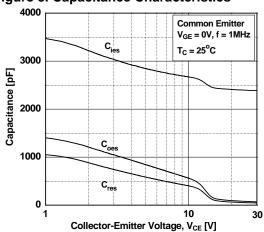


Figure 10. SOA Characteristics

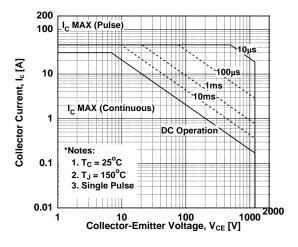


Figure 12. Turn-off Characteristics vs.
Gate Resistance

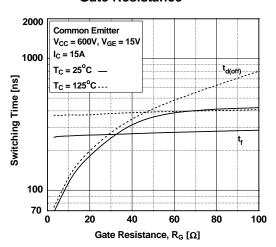


Figure 13. Turn-on Characteristics vs. **Collector Current**

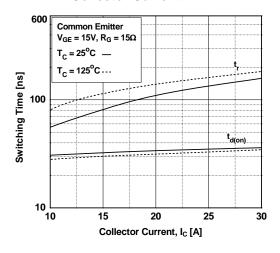


Figure 14. Turn-off Characteristics vs. **Collector Current**

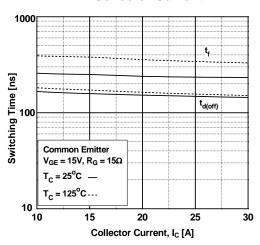


Figure 15. Switching Loss vs. Gate Resistance

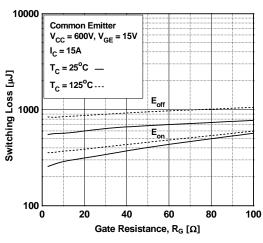


Figure 16. Switching Loss vs. Collector Current

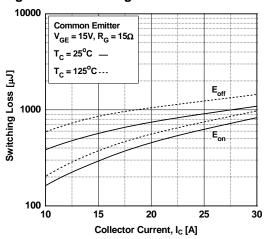
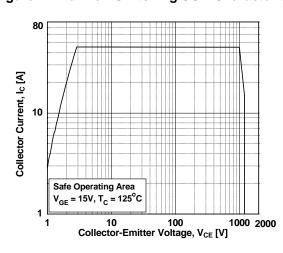


Figure 17. Turn off Switching SOA Characteristics Figure 18. Forward Characteristics



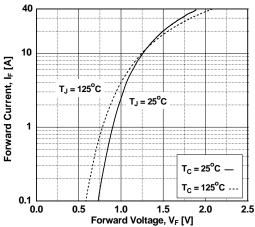


Figure 19. Reverse Recovery Current

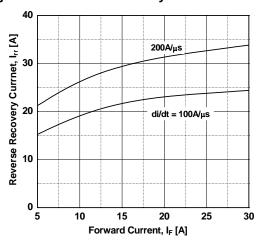


Figure 20. Stored Charge

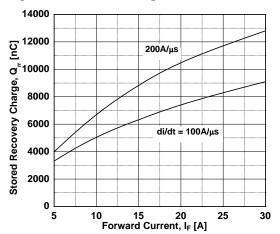


Figure 21.Reverse Recovery Time

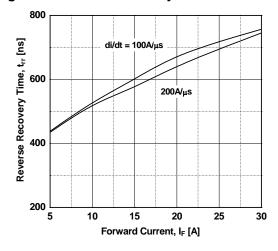
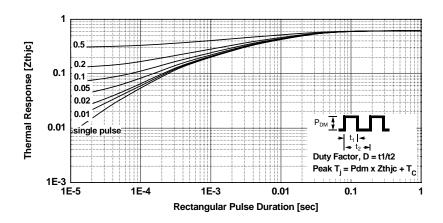
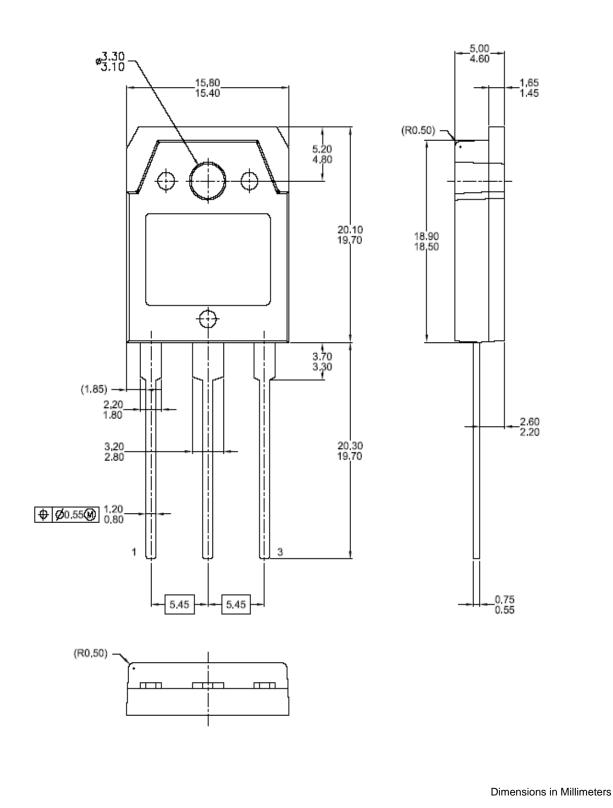


Figure 22. Transient Thermal Impedance of IGBT



Mechanical Dimensions

TO-3PN







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